

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
In re the Application of:

Inventor: Masanori MINAMIO, et al. Prior Art Unit: 2815
Appln. No.: Divisional Appln. based Prior Examiner: L. C. Cruz
On Appln. No. 09/380,312
filed August 31, 1999
Filed: December 31, 2003
For: RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A METHOD OF
MANUFACTURING THE SAME

CONFIRMATION CLAIM FOR PRIORITY

Assistant Commissioner of Patents
Washington, D.C. 20231

Sir:

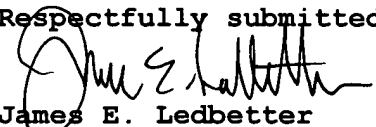
The benefit of the filing date of the following foreign
application filed in the following foreign country and priority
provided in the 35 USC §119 have been claimed for the above-identified
application:

JAPANESE PATENT APPLICATION NO. 9-171395
FILED June 27, 1997 and

JAPANESE PATENT APPLICATION NO. 10-73711
FILED March 23, 1998.

The International Bureau received the priority document within the
time limit in parent application serial no. 09/380,312 filed August 31,
1999.

It is requested that the file of this application be marked to
indicate that the requirements of 35 USC §119 have been fulfilled and
that the Patent and Trademark Office kindly acknowledge receipt of
these papers.

Respectfully submitted,

James E. Ledbetter
Registration No. 28,732

Date: December 31, 2003

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